AN8130K

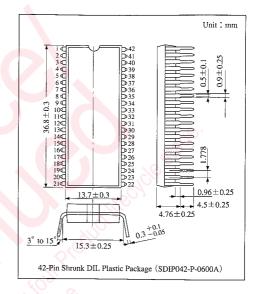
High-speed and Low Power Consumption 10-bit A/D Converter IC

Overview

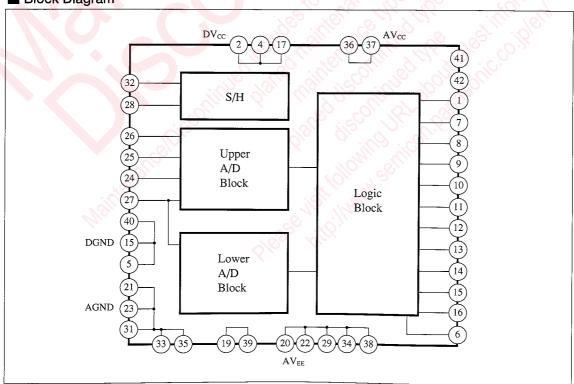
The AN8130K is a 10-bit A/D converter for video processing and it offers low power consumption adopting Bi-CMOS process.

Features

- 10-bit resolution
- High speed: max. conversion rate 20MSPS
- Low power consumption: 750mW
- S/H circuit built-in
- Serial/parallel type



Block Diagram



■ Absolute Maximum Ratings $(Ta=25^{\circ}C)$

Parameter	Symbol	Rating	Unit
Consideration	V_{EE}	-6 to $+0.5$	V
Supply voltage	V _{cc}	-0.5 to +6	V
Analog input voltage	V _{IN}	V _{EE} to V _{CC}	V
Digital input voltage	V _{CLKSH} /V _{CLKAD}	-0.5 to $V_{\rm CC}+0.5$	V
Reference voltage	V _{RB} /V _{RT}	V _{EE} to +0.5	V
Digital output current	I _{OH}	-15	mA
Power dissipation	P_D	1100	mW
Operating ambient temperature	Topr	-20 to +70	°C
Storage temperature	T _{stg}	-55 to +150	C

■ Recommended Operating Range (Ta=25°C)

Parameter	Symbol	min	typ	max 🎺	Unit
Positive supply voltage	Vcc	4.75	5	5.25	V
Negative supply voltage	V _{EE}	-5.25	-5	-4.75	v
Deference veltege	V _{RT}		0		V
Reference voltage	V_{RB}		-2	P —	V
Analog input voltage	V _{IN}	V_{RB}		V _{RT}	V
Digital input voltage	V _{IH}	2	400	4	V
Digital input voltage	V _{IL}	0	~ ~ · ·	0.8	V
Digital autust assess	I _{OH}	— i	-0.4		mA
Digital output current	I _{OL}	-10	1.6	-9-	mA
S/H clock input pulse width	t _H *	15	20	,00	ns
A/D clock input pulse width	t _H *	35	40	$\beta \gamma = - \gamma \gamma$	ns

^{*} At $f_{CLK} = 16MH_Z$

■ Electrical Characteristics $(V_{CC}=5V, V_{EE}=-5V, Ta=25^{\circ}C)$

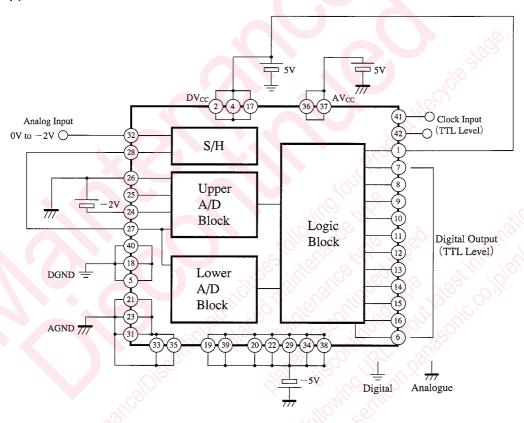
Parameter	Symbol	Condition	min	typ	max	Unit
	DI_{CC}			5	10	mA
Supply current	AI_{CC}	in the size of the	200	14	28	mA
	I_{EE}	9/0 0, 10	- 164	-131		mA
Reference resistor current	I_{RT}	V _{RT} =0V	2.4	3	3.6	mA
Reference resistor current	I_{RB}	$V_{RB} = -2V$	-3.6	-3	-2.4	mA
Input bias current	I_{IN}	$V_{INSB} = -1V$		10	100	μΑ
Cloak input august	I_{IH}	$V_{\text{CLKAD}} = V_{\text{CLKSH}} = 2.7V$		1	8	μ A
Clock input current	$ m I_{IL}$	$V_{\text{CLKAD}} = V_{\text{CLKSH}} = 0.4V$		1	8	μA
Digital autout valtage	V_{OH}	$I_{OB} = -400 \mu \text{ A}$	2.7	3.4		V
Digital output voltage	V_{OL}	$I_{OL}=1.6\text{mA}$			0.4	V
Linearity error	E_L	$V_{IN} = 2V_{PP}$		±1		LSB
Differential linearity error	E_D	$V_{IN}=2V_{PP}$		±0.5	±1	LSB
Maximum conversion rate	F _C	$V_{IN}=2V_{PP}$	20		—	MSPS
	S/N	$f_{CLK}=16MH_{Z}, f_{IN}=1MH_{Z}$		53		dB
Quantization noise		$f_{CLK}=16MH_{Z}, f_{IN}=8MH_{Z}$		49	·	dB
Quantization noise		$f_{CLK}=20MH_{Z}, f_{IN}=1MH_{Z}$		52		dB
		$f_{CLK}=20MH_{Z}, f_{IN}=8MH_{Z}$		47		đΒ

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Electrical Characteristics (cont.) $(V_{CC}=5V, V_{EE}=-5V, Ta=25^{\circ}C)$

Parameter	Symbol	Condition	min	typ	max	Unit
Differential gain	DG	IRE standard 15kHz Sawtooth 40%		0.5	1	%
Differential phase	DP	subcarrier f _{CLK} =20MHz, Nolock		0.5	1	deg
Digital output delay	τd			33		ns
Clock delay	τ CLK	f _{CLK} =16MHz	-5	0	5	ns
Input capacitance	C _{IN}			10		pF
Input offset voltage	V _{OFS}			0	_	V

■ Application Circuit



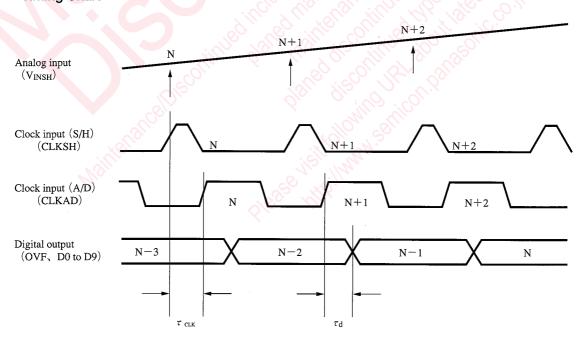
■ Pin Descriptions

Pin No.	Symbol	Description	Typ. waveform	Voltage level	Pin No.	Symbol	Description	Typ. waveform	Voltage level						
1	INV	Digital output inversion pin		TTL	22	AV_{EE}	Analog negative supply voltage	_	-5V						
2	$\mathrm{DV}_{\mathrm{CC}}$	Digital positive supply voltage		5V	23	AGND	Analog GND		0V						
3	N.C.	Non connection	_	. —	24	V_{RB}	Reference voltage low level		-2V						
4	DV_{CC}	Digital positive supply voltage		5V	25	V _{RM}	Reference voltage midpoint level								
5	DGND	Digital GND		0V	26	V_{RT}	Reference voltage high level		0V						
6	OVF	Overflow pin			27	V _{INAD}	Analog input (A/D)	\sim	0 to -2V						
7	D0	Digital output (LSB)			28	V _{OSH}	Analog output (S/H)	\sim	0 to −2V						
8	D1	Digital output			29	AVEE	Analog negative supply voltage		-5V						
9	D2	Digital output			30	NC	Non connection								
10	D3	Digital output	Refer to the timing chart.		31	AGND	Analog GND	700	0V						
11	D4	Digital output		the timing	TTL	32	V _{INSH}	Analog input (S/H)	\sim	0 to −2V					
12	D5	Digital output			chart.	chart.	chart.	chart.		chart.	33	AGND	Analog GND		0V
13	D6	Digital output				34	AV _{EE}	Analog negative supply voltage		-5V					
14	D7	Digital output			35	AGND	Analog GND		0V						
15	D8	Digital output			36	AV _{CC}	Analog positive supply voltage		5V						
16	D9	Digital output (MSB)			37	AV_{CC}	Analog positive supply voltage		5V						
17	DV_{CC}	Digital positive supply voltage		5V	38	AVEE	Analog negative supply voltage		-5V						
18	DGND	Digital GND	_	0V	39	AVEE	Analog negative supply voltage		-5V						
19	AV_{EE}	Analog negative supply voltage		-5V	40	DGND	Digital GND		0V						
20	AV_{EE}	Analog negative supply voltage	_	-5V	41	CLKSH	Clock input (S/H)	Refer to	Oneny.						
21	AGND	Analog GND	\rightarrow	0V	42	CLKAD	Clock input (A/D)	the timing chart.	TTL						

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■ Supplementary Explanation

Timing Chart



■ Supplementary Explanation (cont.) • Output Code

· · · · · · · · · · · · · · · · · · ·	Input signal	Digital output OVFM L 0123456789		
Step	2.000VFS 1.953mV STEP			
	INV= "H"			
000	-0.000000	0000000000		
001	-0.001953	0000000001		
•				
•		•		
•	•	·		
511	-0.998047	0011111111		
512	-1.000000	0100000000		
513	-1.001953	0100000001		
•				
		- 500		
•		0.1111111		
1023	-1.998047	0111111111		
1024	-2.000000	1111111111		

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